Vishay Siliconix



**HVMDIP** 

**PRODUCT SUMMARY** 

V<sub>DS</sub> (V)

 $R_{DS(on)}(\Omega)$ 

Q<sub>q</sub> (Max.) (nC)

Q<sub>gs</sub> (nC)

Q<sub>gd</sub> (nC)

Configuration

## **Power MOSFET**

s

N-Channel MOSFET

3.6

400

17

3.4

8.5

Single

 $V_{GS} = 10 V$ 

### FEATURES

- Dynamic dV/dt rating
- Repetitive avalanche rated
- For automatic insertion
- End stackable
- Fast switching
- Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The 4 pin DIP package is a low cost machine-insertiable case style which can be stacked in multiple combinations on standard 0.1" pin centers. The dual drain serveres as a thermal link to the mounting surface for power dissipation levels up to 1 W.

ORDERING INFORMATION	
Package	HVMDIP
Lead (Pb)-free	IRFD310PbF

<b>ABSOLUTE MAXIMUM RATINGS (TA</b>	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V <sub>DS</sub>	400	v	
Gate-source voltage			V <sub>GS</sub>	± 20		
Continuous drain current	V <sub>GS</sub> at 10 V	T <sub>A</sub> = 25 °C	- I <sub>D</sub>	0.35		
Continuous drain current	V <sub>GS</sub> at 10 V	T <sub>A</sub> = 100 °C		0.22	А	
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	2.8	1	
Linear derating factor				0.0083	W/°C	
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	46	mJ	
Repetitive avalanche current <sup>a</sup>			I <sub>AR</sub>	0.35	А	
Repetitive avalanche energy <sup>a</sup>			E <sub>AR</sub>	0.10	mJ	
Maximum power dissipation $T_A = 25 \text{ °C}$		PD	1.0	W		
Peak diode recovery dV/dt <sup>c</sup>			dV/dt	4.0	V/ns	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C		
Soldering recommendations (peak temperature)	For 10 s			300 <sup>d</sup>		

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b.  $V_{DD}$  = 50 V, starting T<sub>J</sub> = 25 °C, L = 41 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 1.4 A (see fig. 12)

c.  $I_{SD} \leq 2.0$  A,  $dI/dt \leq 40$  A/µs,  $V_{DD} \leq V_{DS}$ ,  $T_J \leq 150$  °C

d. 1.6 mm from case





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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	120	°C/W	

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> :	= 0 V, I <sub>D</sub> = 250 μA	400	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.47	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μΑ	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 20 V	-	-	± 100	nA
Zero Gate Voltage Drain Current	<b>I</b>	V <sub>DS</sub> =	= 400 V, V <sub>GS</sub> = 0 V	-	-	25	
zero date voltage Drain Current	IDSS	V <sub>DS</sub> = 320 V	$V_{DS} = 320 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{\text{J}} = 125 ^{\circ}\text{C}$		-	250	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 0.21 A <sup>b</sup>	-	-	3.6	Ω
Forward Transconductance	<b>g</b> fs	V <sub>DS</sub>	V <sub>DS</sub> = 50 V, I <sub>D</sub> = 1.2 A		-	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 25 V,$ f = 1.0 MHz, see fig. 5		-	170	-	pF
Output Capacitance	C <sub>oss</sub>			-	34	-	
Reverse Transfer Capacitance	C <sub>rss</sub>			-	6.3	-	
Total Gate Charge	Qg			-	-	17	
Gate-Source Charge	$Q_gs$	$V_{GS} = 10 V$	I <sub>D</sub> = 2.0 A, V <sub>DS</sub> = 320 V, see fig. 6 and 13 <sup>b</sup>	-	-	3.4	nC
Gate-Drain Charge	Q <sub>gd</sub>	1		-	-	8.5	
Turn-On Delay Time	t <sub>d(on)</sub>			-	8.0	-	
Rise Time	t <sub>r</sub>	V <sub>DD</sub> =	200 V, I <sub>D</sub> = 2.0 A,	-	9.9	-	
Turn-Off Delay Time	t <sub>d(off)</sub>	$R_g = 24 \Omega$ , $R_D = 95 \Omega$ , see fig. 10 <sup>b</sup>		-	21	-	ns
Fall Time	t <sub>f</sub>	1		-	11	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.0	-	
Internal Source Inductance	L <sub>S</sub>			-	6.0	-	nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the		-	-	0.35	•
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	integral revers p - n junction		-	-	2.8	A
Body Diode Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C,	$I_{\rm S} = 0.35$ A, $V_{\rm GS} = 0$ V <sup>b</sup>	-	-	1.6	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	- T <sub>J</sub> = 25 °C, I <sub>F</sub> = 2.0 A, dl/dt = 100 A/µs <sup>b</sup>		-	240	540	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	0.85	1.6	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic tu	rn-on time is negligible (turn	-on is dor	ninated b	y L <sub>S</sub> and	L <sub>D</sub> )

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %

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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

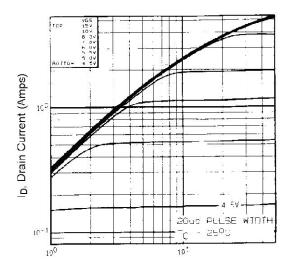


Fig. 1 - Typical Output Characteristics,  $T_A = 25 \ ^\circ C$ 

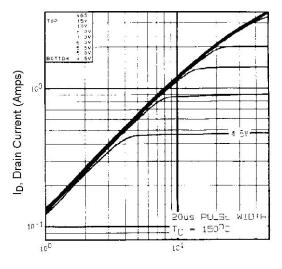


Fig. 1 - Typical Output Characteristics, T<sub>A</sub> = 150 °C

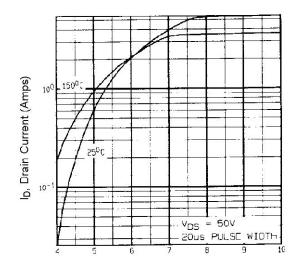


Fig. 2 - Typical Transfer Characteristics

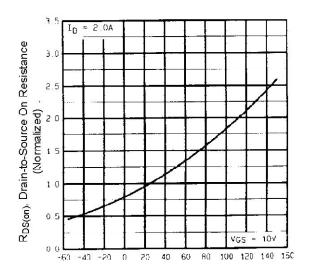


Fig. 3 - Normalized On-Resistance vs. Temperature



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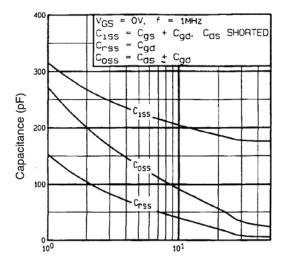


Fig. 4 - Typical Capacitance vs. Drain-to-Source Voltage

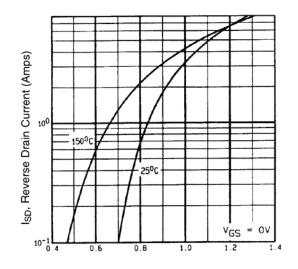


Fig. 6 - Typical Source-Drain Diode Forward Voltage

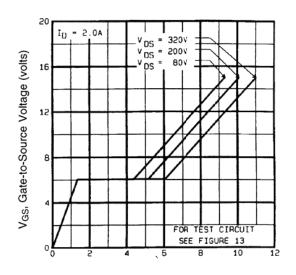


Fig. 5 - Typical Gate Charge vs. Gate-to-Source Voltage

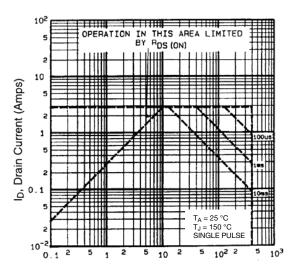


Fig. 7 - Maximum Safe Operating Area

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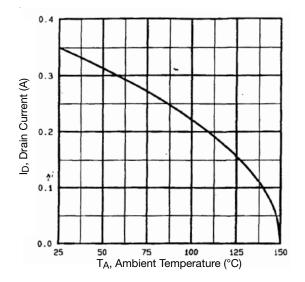


Fig. 8 - Maximum Drain Current vs. Ambient Temperature

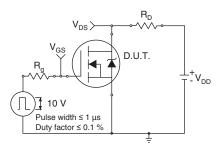


Fig. 10a - Switching Time Test Circuit

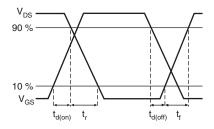


Fig. 10b - Switching Time Waveforms

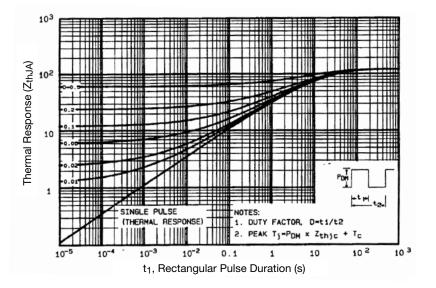


Fig. 9 - Maximum Effective Transient Thermal Impedance, Junction-to-Ambient



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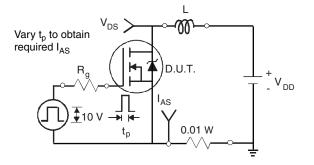


Fig. 12a - Unclamped Inductive Test Circuit

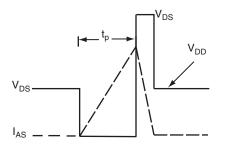


Fig. 12b - Unclamped Inductive Waveforms

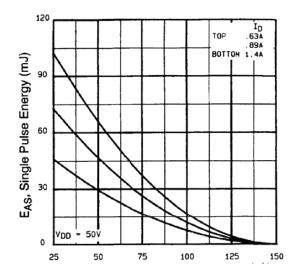
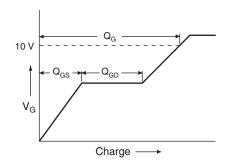


Fig. 12c - Maximum Avalanche Energy vs. Drain Current





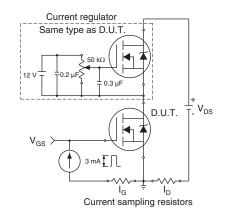


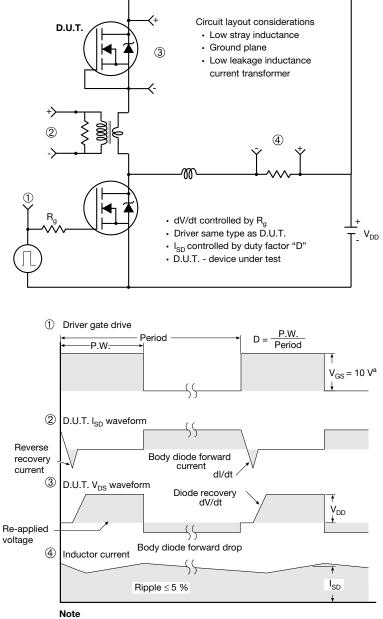
Fig. 13b - Gate Charge Test Circuit

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#### Peak Diode Recovery dV/dt Test Circuit



a.  $V_{GS}$  = 5 V for logic level devices

Fig. 10 - For N-Channel

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#### HVM DIP (High voltage)





	INCHES		MILLIN	IETERS
DIM.	MIN.	MAX.	MIN.	MAX.
А	0.310	0.330	7.87	8.38
E	0.300	0.425	7.62	10.79
L	0.270	0.290	6.86	7.36
ECN: X10-0386-Rev. B, 0 DWG: 5974	06-Sep-10			

Note

1. Package length does not include mold flash, protrusions or gate burrs. Package width does not include interlead flash or protrusions.



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